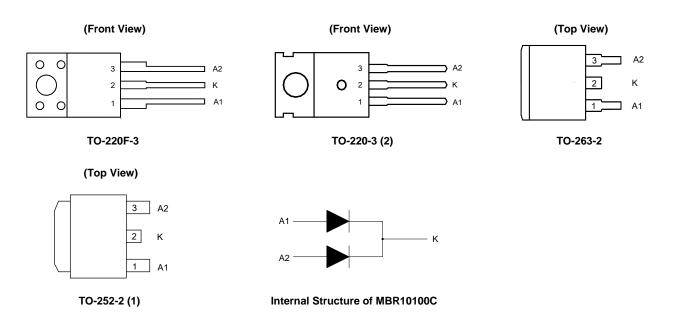
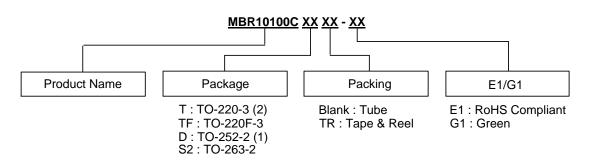


Pin Assignments



Ordering Information





| Package | Part Number | Marking ID | Packing |
|--------------|------------------|----------------|------------------------|
| TO-220-3 (2) | MBR10100CT-E1 | MBR10100CT-E1 | 50 Pieces/Tube |
| TO-220-3 (2) | MBR10100CT-G1 | MBR10100CT-G1 | 50 Pieces/Tube |
| TO-220F-3 | MBR10100CTF-E1 | MBR10100CTF-E1 | 50 Pieces/Tube |
| TO-220F-3 | MBR10100CTF-G1 | MBR10100CTF-G1 | 50 Pieces/Tube |
| TO-263-2 | MBR10100CS2-E1 | MBR10100CS2-E1 | 50 Pieces/Tube |
| TO-263-2 | MBR10100CS2-G1 | MBR10100CS2-G1 | 50 Pieces/Tube |
| TO-263-2 | MBR10100CS2TR-E1 | MBR10100CS2-E1 | 800 Pieces/Tape & Reel |
| TO-263-2 | MBR10100CS2TR-G1 | MBR10100CS2-G1 | 800 Pieces/Tape & Reel |



Ordering Information (Cont.)

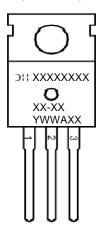


| Package | Part Number | Marking ID | Packing |
|--------------|-----------------|---------------|-------------------------|
| TO-252-2 (1) | MBR10100CD-E1 | MBR10100CD-E1 | 80 Pieces/Tube |
| TO-252-2 (1) | MBR10100CD-G1 | MBR10100CD-G1 | 80 Pieces/Tube |
| TO-252-2 (1) | MBR10100CDTR-E1 | MBR10100CD-E1 | 2500 Pieces/Tape & Reel |
| TO-252-2 (1) | MBR10100CDTR-G1 | MBR10100CD-G1 | 2500 Pieces/Tape & Reel |

Marking Information

(1) TO-220-3 (2)

(Front View)

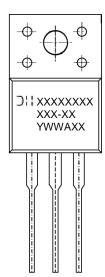


First and Second Lines: Logo and Marking ID (See Ordering Information) Third Line: Date Code Y: Year WW: Work Week of Molding A: Assembly House Code

XX: 7th and 8th Digits of Batch Number

(2) TO-220F-3

(Front View)



First and Second Lines: Logo and Marking ID

(See Ordering Information)
Third Line: Date Code

Y: Year

WW: Work Week of Molding

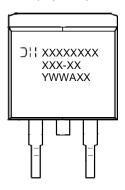
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number



Marking Information (Cont.)

(3) TO-263-2

(Top View)



First and Second Lines: Logo and Marking ID (See Ordering Information) Third Line: Date Code

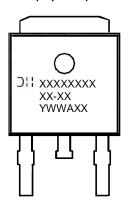
Y: Year

WW: Work Week of Molding A: Assembly House Code

XX: 7th and 8th Digits of Batch Number

(4) TO-252-2 (1)

(Top View)



First and Second Lines: Logo and Marking ID (See Ordering Information)
Third Line: Date Code

Y: Year

WW: Work Week of Molding

A: Assembly House Code XX: 7th and 8th Digits of Batch Number



Maximum Ratings (Each Diode Leg) (Note 4)

| Characteristic | Symbol | Rating | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 100 | V |
| Average Rectified Forward Current (Rated V_R) $T_C = +136$ °C | I _{F(AV)} | 5 | А |
| Peak Repetitive Forward Current (Rated V _R , Square Wave, 20kHz) T _C = +134°C | I _{FRM} | 10 | А |
| Non Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Half Wave, Single Phase, 60Hz) | I _{FSM} | 100 | А |
| Operating Junction Temperature Range (Note 5) | TJ | -55 to +150 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | °C |
| Voltage Rate of Change (Rated V _R) | d∨/dt | 10000 | V/µs |
| ESD (Machine Model = C) | _ | > 400 | V |
| ESD (Human Body Model = 3B) | _ | > 8000 | V |

Notes: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied.

Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Thermal Characteristics

| Characteristic | Symbol | Rating | | Unit |
|--|-------------------|---------------------------|-----|------|
| Maximum Thermal Resistance (Junction to Case) (Note 6) | | TO-220-3 (2)/TO-252-2 (1) | 3.0 | |
| | R _θ JC | TO-220F-3 | 4.5 | °C/W |
| (Note o) | | TO-263-2 | 2.0 | |
| | R _{θJA} | TO-220-3 (2)/TO-252-2 (1) | 60 | |
| Maximum Thermal Resistance (Junction to Ambient (Note 6) | | TO-220F-3 | 60 | °C/W |
| (Note o) | | TO-263-2 | 50 | |

Note 6: Device mounted on heat sink, with minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

^{5.} The heat generated must be less than the thermal conductivity from Junction to Ambient: $dP_D/dT_J < 1/\theta_{JA}$.



Electrical Characteristics

| Characteristic | Symbol | Rating | Unit | Test Condition |
|--|----------------|--------|------|--|
| Maximum Instantaneous Forward Voltage Drop | | 0.85 | V | I _F = 5A, T _C = +25°C |
| (Note 7) | VF | 0.75 | | I _F = 5A, T _C = +125°C |
| | | 6.0 | mA | Rated DC Voltage, T _C = +125°C |
| Maximum Instantaneous Reverse Current (Note 7) | I _R | 0.1 | | Rated DC Voltage, T _C = +25°C |

Note 7: Short duration pulse test used to minimize self-heating effect, Pulse Test Width = 300µs, Duty Cycle < 2.0%.

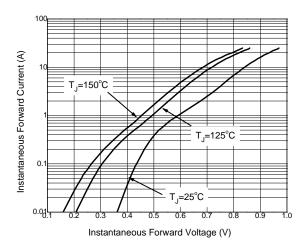


Figure 1. Typical Forward Voltage Per Diode

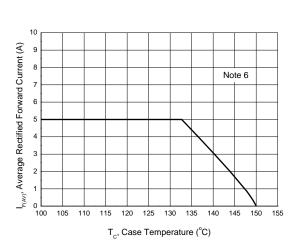


Figure 3. Average Rectified Forward Current vs.

Case Temperature (Per Diode)

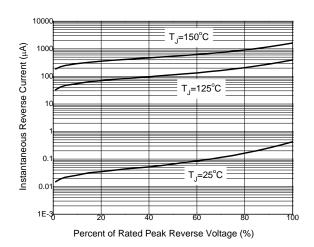
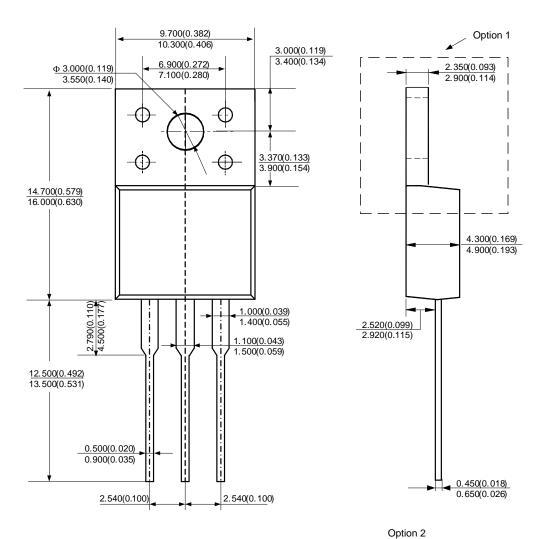


Figure 2. Typical Reverse Current Per Diode



Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: TO-220F-3

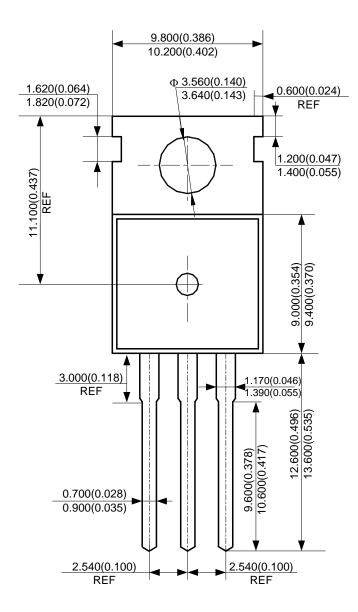


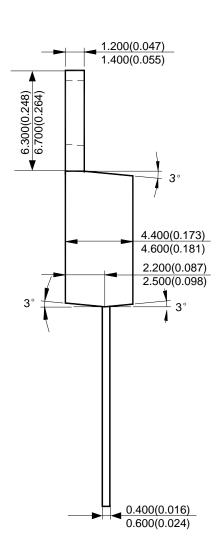
5° | 5° | 5° |



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(2) Package Type: TO-220-3 (2)

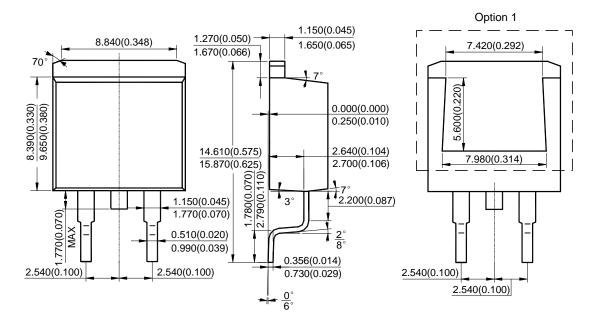


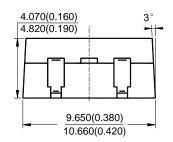


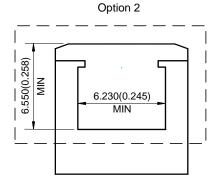


Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(3) Package Type: TO-263-2



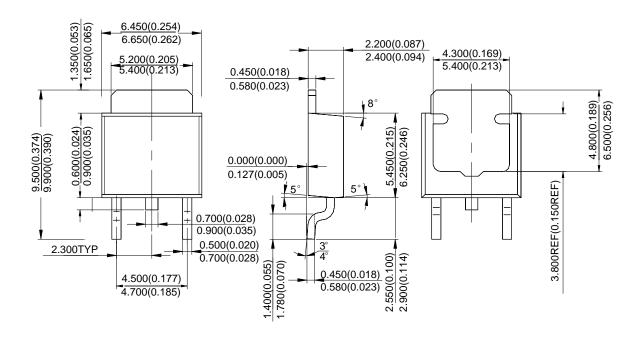






Package Outline Dimensions (Cont. All dimensions in mm(inch).)

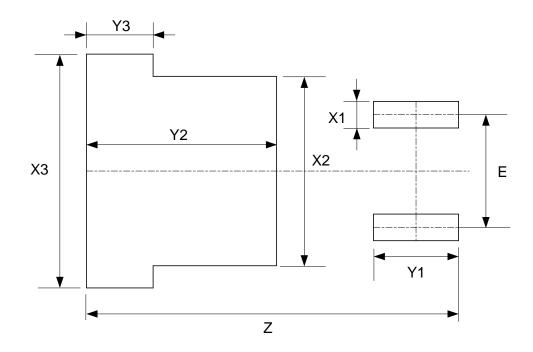
(4) Package Type: TO-252-2 (1)





Suggested Pad Layout

(1) Package Type: TO-263-2

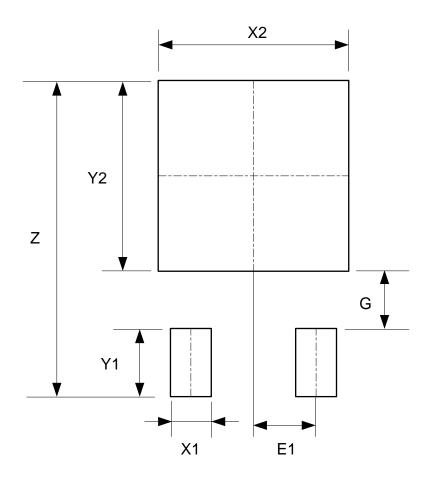


| Dimensions | Z | X1 | X2 | X3 |
|------------|--------------------------|-------------|--------------------------|-------------|
| | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) |
| Value | 16.760/0.660 1.200/0.047 | | 8.540/0.336 10.540/0.415 | |
| Dimensions | Y1 | Y2 | Y3 | E |
| | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) |
| Value | 3.830/0.151 | 8.560/0.337 | 3.000/0.118 | 5.080/0.200 |



Suggested Pad Layout (Cont.)

(2) Package Type: TO-252-2 (1)



| Dimensions | Z | X1 | X2=Y2 | Y1 | G | E1 |
|------------|--------------|-------------|-------------|-------------|-------------|-------------|
| Dimensions | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) | (mm)/(inch) |
| Value | 11.600/0.457 | 1.500/0.059 | 7.000/0.276 | 2.500/0.098 | 2.100/0.083 | 2.300/0.091 |



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